

## THD200FI

# HIGH VOLTAGE FAST-SWITCHING NPN POWER TRANSISTOR

- SGS-THOMSON PREFERRED SALESTYPE
- HIGH VOLTAGE CAPABILITY
- VERY HIGH SWITCHING SPEED
- U.L. RECOGNISED ISOWATT218 PACKAGE (U.L. FILE # E81734 (N))

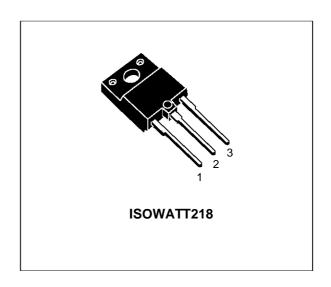
#### **APPLICATIONS:**

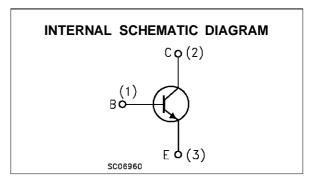
 HORIZONTAL DEFLECTION FOR MONITORS

#### **DESCRIPTION**

The THD200FI is manufactured using Multiepitaxial Mesa technology for cost-effective high performance and uses a Hollow Emitter structure to enhance switching speeds.

The THD series is designed for use in horizontal deflection circuits in televisions and monitors.





#### **ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Value	Unit
V <sub>CBO</sub>	Collector-Base Voltage (I <sub>E</sub> = 0)	1500	V
V <sub>CEO</sub>	Collector-Emitter Voltage (I <sub>B</sub> = 0)	700	V
$V_{EBO}$	Emitter-Base Voltage (I <sub>C</sub> = 0)	10	V
Ic	Collector Current	10	A
I <sub>CM</sub>	Collector Peak Current (t <sub>p</sub> < 5 ms)	20	A
$I_{B}$	Base Current	5	A
I <sub>BM</sub>	Base Peak Current (t <sub>p</sub> < 5 ms)	10	A
P <sub>tot</sub>	Total Dissipation at T <sub>c</sub> = 25 °C	57	W
T <sub>stg</sub>	Storage Temperature	-65 to 150	°C
Tj	Max. Operating Junction Temperature	150	°C

September 1997

#### THD200FI

#### THERMAL DATA

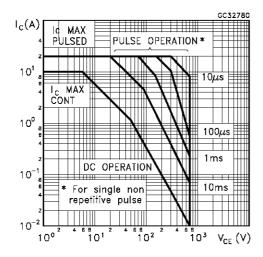
R <sub>thj-case</sub> Thermal Resistance Junction-case	Max	2.2	°C/W
--	-----	-----	------

### **ELECTRICAL CHARACTERISTICS** ( $T_{case} = 25$ °C unless otherwise specified)

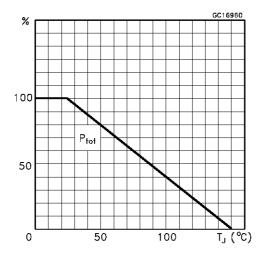
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
I <sub>CES</sub>	Collector Cut-off Current (V <sub>BE</sub> = 0)	V <sub>CE</sub> = 1500 V V <sub>CE</sub> = 1500 V T <sub>j</sub> = 125 °C			0.2 2	mA mA
I <sub>EBO</sub>	Emitter Cut-off Current (I <sub>C</sub> = 0)	V <sub>EB</sub> = 5 V			100	μΑ
V <sub>CEO(sus)</sub>	Collector-Emitter Sustaining Voltage	I <sub>C</sub> = 100 mA	700			V
V <sub>EBO</sub>	Emitter-Base Voltage (I <sub>C</sub> = 0)	I <sub>E</sub> = 10 mA	10			V
V <sub>CE(sat)</sub> *	Collector-Emitter Saturation Voltage	I <sub>C</sub> = 7 A I <sub>B</sub> = 1.5 A			1.5	V
V <sub>BE(sat)*</sub>	Base-Emitter Saturation Voltage	I <sub>C</sub> = 7 A I <sub>B</sub> = 1.5 A			1.3	V
h <sub>FE</sub> *	DC Current Gain	$I_{C} = 7 \text{ A}$ $V_{CE} = 5 \text{ V}$ $I_{C} = 7 \text{ A}$ $V_{CE} = 5 \text{ V}$ $T_{j} = 100 ^{\circ}\text{C}$	6.5 4		13	
t <sub>s</sub>	RESISTIVE LOAD Storage Time Fall Time	$V_{CC} = 400 \text{ V}$ $I_{C} = 7 \text{ A}$ $I_{B1} = 1.5 \text{ A}$ $I_{B2} = 3.5 \text{ A}$		2.1 140	3.1 210	μs ns
t <sub>s</sub> t <sub>f</sub>	INDUCTIVE LOAD Storage Time Fall Time	$I_{C} = 7 \text{ A}$ f = 31250 Hz $I_{B1} = 1.5 \text{ A}$ $I_{B2} = -3.5 \text{ A}$ $V_{ceflyback} = 1200 \sin\left(\frac{\pi}{5} \cdot 10^{6}\right) t$ V		3.5 320		μs ns
t <sub>s</sub> t <sub>f</sub>	INDUCTIVE LOAD Storage Time Fall Time	$I_{C} = 7 \text{ A}$ f = 64 KHz $I_{B1} = 1.5 \text{ A}$ $I_{B2} = -3.5 \text{ A}$ $V_{ceflyback} = 1200 \sin\left(\frac{\pi}{5} \cdot 10^{6}\right) t$ V		1.7 215		μs ns

<sup>\*</sup> Pulsed: Pulse duration = 300 μs, duty cycle 1.5 %

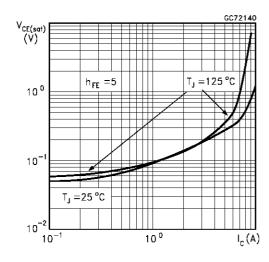
#### Safe Operating AreaDerating Curve



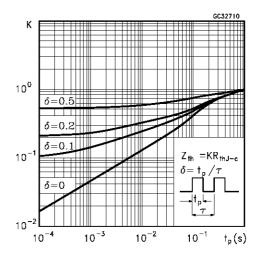
#### **Derating Curve**



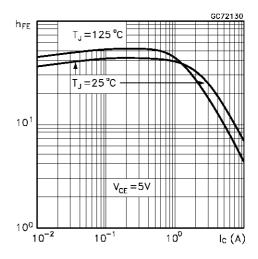
#### Collector Emitter Saturation Voltage



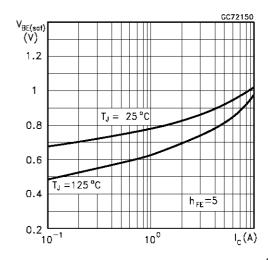
#### Thermal Impedance



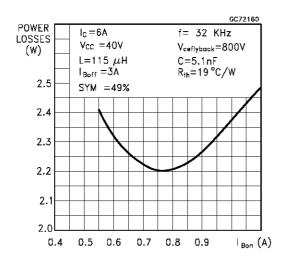
DC Current Gain



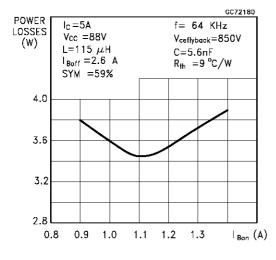
Base Emitter Saturation Voltage



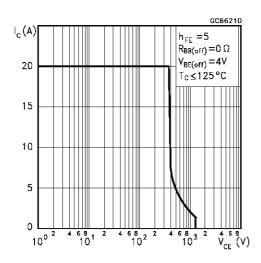
#### Power Losses at 32 KHz



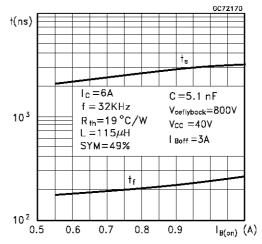
#### Power Losses at 64 KHz



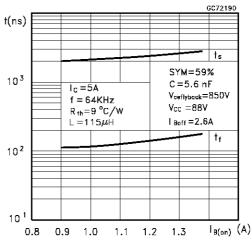
#### Reverse Biased SOA



# Switching Time Inductive Load at 32 KHz (see figure 2)



# Switching Time Inductive Load at 64 KHz (see figure 2)



#### **BASE DRIVE INFORMATION**

In order to saturate the power switch and reduce conduction losses, adequate direct base current  $I_{B1}$  has to be provided for the lowest gain  $h_{FE}$  at  $T_j$  = 100  $^{\circ}$ C (line scan phase). On the other hand, negative base current  $I_{B2}$  must be provided turn off the power transistor (retrace phase). Most of the dissipation, especially in the deflection application, occurs at switch-off so it is essential to determine the value of  $I_{B2}$  which minimizes power losses, fall time  $t_f$  and, consequently,  $T_j$ . A new set of curves have been defined to give total power losses,  $t_s$  and  $t_f$  as a function of  $I_{B2}$  at both 32 KHz and 64 KHz scanning frequencies in order to choice the optimum negative drive. The test circuit is illustrated in fig. 1.

Inductance  $L_1$  serves to control the slope of the negative base current  $I_{B2}$  in order to recombine the excess carriers in the collector when base current is still present, thus avoiding any tailing phenomenon in the collector current.

The values of L and C are calculated from the following equations:

$$\frac{1}{2}L(I_C)^2 = \frac{1}{2}C(V_{CEfly})^2$$
$$\omega = 2\pi f = \frac{1}{\sqrt{LC}}$$

Where  $I_C$  = operating collector current,  $V_{CEfly}$ = flyback voltage, f= frequency of oscillation during retrace.

Figure 1: Inductive Load Switching Test Circuit.

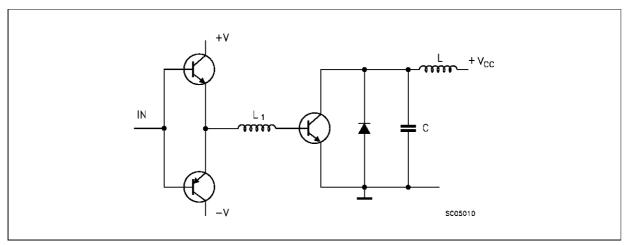
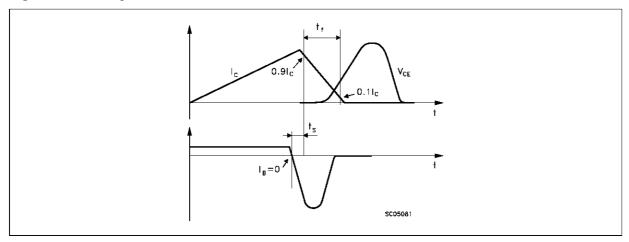
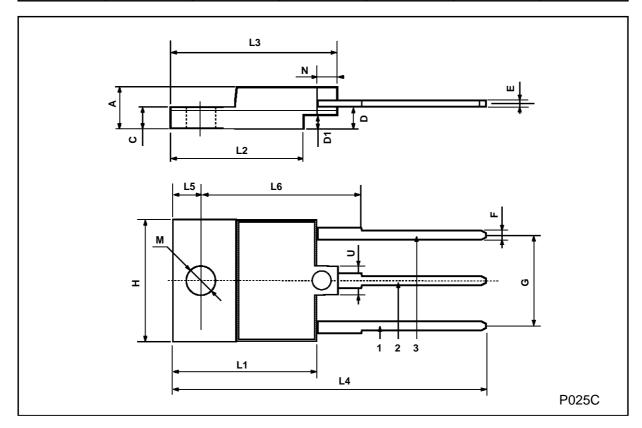


Figure 2: Switching Waveforms in a Deflection Circuit.



### **ISOWATT218 MECHANICAL DATA**

DIM.		mm			inch	
Dilvi.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А	5.35		5.65	0.210		0.222
С	3.3		3.8	0.130		0.149
D	2.9		3.1	0.114		0.122
D1	1.88		2.08	0.074		0.081
E	0.75		1	0.029		0.039
F	1.05		1.25	0.041		0.049
G	10.8		11.2	0.425		0.441
Н	15.8		16.2	0.622		0.637
L1	20.8		21.2	0.818		0.834
L2	19.1		19.9	0.752		0.783
L3	22.8		23.6	0.897		0.929
L4	40.5		42.5	1.594		1.673
L5	4.85		5.25	0.190		0.206
L6	20.25		20.75	0.797		0.817
М	3.5		3.7	0.137		0.145
N	2.1		2.3	0.082		0.090
U		4.6			0.181	



Information furnished is believed to be accurate and reliable. However, SGS-THOMSON Microelectronics assumes no responsability for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may results from its use. No license is granted by implication or otherwise under any patent or patent rights of SGS-THOMSON Microelectronics. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied. SGS-THOMSON Microelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of SGS-THOMSON Microelectonics.

© 1997 SGS-THOMSON Microelectronics - Printed in Italy - All Rights Reserved

SGS-THOMSON Microelectronics GROUP OF COMPANIES

Australia - Brazil - Canada - China - France - Germany - Hong Kong - Italy - Japan - Korea - Malaysia - Malta - Morocco - The Netherlands - Singapore - Spain - Sweden - Switzerland - Taiwan - Thailand - United Kingdom - U.S.A

